

8-Channel Constant Current Driver

Product Description

SCT2008 is an eight channels constant current driver for the LED lighting. It provides the finest PWM control effect with its ability to sink constant current from LED clusters with minimum pulse width only 80nS. The PWM control is performed by connecting the PWM signal from system control unit to OE pin of SCT2008. The full scale current value of each output is set by an external resistor connected to REXT pin.

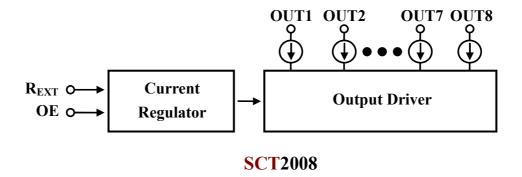
The SCT2008 guarantees to endure maximum DC 24V at each output port. Each output of SCT2008 can sink a constant current up to 160mA. Users can simply shunt the outputs to get higher current driver-ability, especially in the case of high power LED lighting.

The excellent current regulation capability let SCT2008 easily drive each output current to a constant stable status nearly without affecting by power supply of LED, loading due to variant V_F of LEDs and operating temperature. The eight channels IC stops driving the output while junction temperature exceeds 180°C the highest limit and the output will be reactivated while the junction temperature is below the 130°C the low limit of reactivation. Furthermore, with negative temperature coefficient characteristics the driver system and LEDs are protected from damage of thermal runaway or overheated.

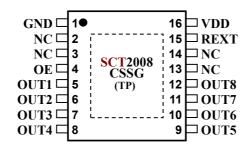
Features

- Eight constant-current outputs rate at 24V
- Constant current range: 10 160mA
- Excellent regulation to load, supply voltage and temperature
- Minimum PWM pulse width 80ns
- ±2%(typ) current matching between outputs
- ±4%(typ) current matching between ICs
- Low dropout output 0.4V@40mA
- All output current are adjusted through one external resistor
- Built-in power on reset and thermal protection
- Supply input voltage: 5V
- Dimming control with Schmitt triggered input
- Package: SSOP16 with heat sink pad
- Application: LED lighting, LED backlight, LED lamp

Block Diagram



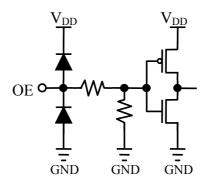
Pin Configuration



Terminal Description

Pin No.	Pin Name	Function
1	GND	Ground terminal
2,3,13,14	NC	No connection
4	OE	Input terminal of output enable signal. Output is enabled when OE is high.
5~12	OUT1~8	Output terminals with constant current
15	REXT	Input terminal connected to an external resistor for setting up all output current
16	VDD	Supply voltage terminal

Equivalent Circuits of Inputs



Ordering information

Part	Package	Unit per reel(pcs)	Marking
SCT2008CSSG	Green SSOP16(150mil) with thermal pad	2500	2008CSSG

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Maximum Ratings (T_A = 25°C)

Characte	eristic	Symbol	Rating	Unit
Supply voltage		V_{DD}	7	V
Input voltage		V _{IN}	-0.2 ~ V _{DD} +0.2	V
Output current		I _{OUT}	180	mA/Ch
Output voltage	V _{OUT}	24	V	
Total GND terminals cur	I _{GND}	1500	mA	
Power dissipation SSOP16TP		P _D	2.08	W
Thermal resistance SSOP16TP		R _{TH(j-a)}	60	°C /W
Operating temperature	T _{OPR}	-40~+85	°C	
Storage temperature	T _{STG}	-55~+150	°C	

Recommended Operating Conditions (T_A=-40 to 85°C unless otherwise noted)

Characteristic	Symbol	Conditions	Min.	Тур.	Max.	Unit
Supply voltage	V_{DD}	-	4.5	-	5.5	V
Output voltage	\/	Output OFF	-	-	24	V
Output voltage	V _{OUT}	Output ON	-	1	4	V
Output current	I _{OUT}	DC test condition	10	-	160	mA
Input voltage	V _{IH}	-	2	-	V_{DD}	V
Input voltage	V _{IL}	-	0	-	0.4	V
OE pulse width t _w		V _{DD} =4.5-5.5V	80	-	-	ns

Electrical Characteristics (V_{DD}=5V, T_A =25°C unless otherwise noted)

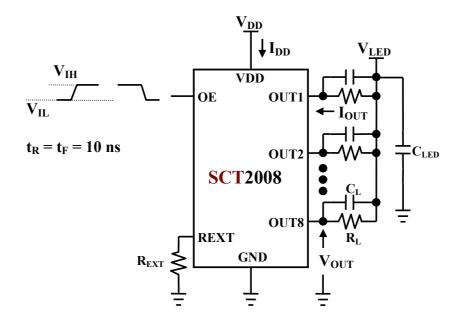
Charact	teristic	Symbol	Conditions		Min.	Тур.	Max.	Unit
Input voltage		V _{IH}		-	2	-	V_{DD}	V
liiput voi	laye	V _{IL}	-		0	-	0.4	V
Output le	eakage	I _{OL}	V _{OUT}	= 24V	-	-	0.5	uA
Output o	urrent	I _{OUT}	V _{OUT} =1V	R _{EXT} =900Ω	-	42	-	mA
Current channel	skew [*]	dl _{OUT1}	V _{OUT} =1V	R _{EXT} =900Ω	-	±2	±3	%
Current skew*	chip	dl _{OUT2}	V _{OUT} =1V	R _{EXT} =900Ω	ı	±4	±6	%
Line reg		%/dV _{DD}	$4.5V < V_{DD} < 5.5V$ $R_{EXT} = 900\Omega, V_{OUT} > 1V$		-	-	±1	%/V
Load regulation I _{OUT} vs. V _{OUT}		%/dV _{OUT}	$1V < V_{OUT} < 4V,$ $R_{EXT}=900\Omega, V_{DD}=5V$		ı	-	±1	%/V
Pull-down resistor		R _{DOWN}	OE		-	500	ı	ΚΩ
Thermal		T _H	Junatian Tamparatura		-	180	1	°C
shutdown		T_L	Junction Temperature		-	130	-	°C
o l OFF		I _{DD(OFF)1}		= Open, OUT₄=OFF	-	6	15	
Supply current	OI I	I _{DD(OFF)2}		= 900Ω, OUT ₄ =OFF	-	9	15	mA
ON I		I _{DD(ON)}		= 900Ω, OUT₄=ON	-	10	15	

^{*} Skew=(I_{OUT} - I_{AVG})/ I_{AVG} , where I_{AVG} =(I_{max} + I_{min})/2

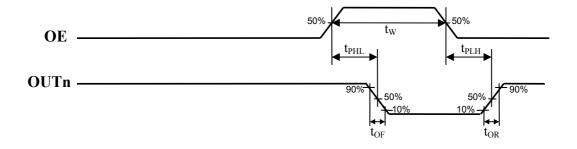
Switching Characteristics (V_{DD} =5V, T_A =25°C unless otherwise noted)

Characteristic		Symbol	Condition	Min.	Тур.	Max.	Unit
Propagation delay time ("L" to "H")	OE - OUTn	t _{PLH}	V _{DD} = 5V V _{LED} = 5V	1	50	100	ns
Propagation delay time ("H" to "L")	OE - OUTn	t _{PHL}	$C_{LED} = 100 uF$ $V_{IH} = V_{DD}$ $V_{II} = GND$	1	30	60	ns
Pulse width	OE	t _w	$R_{EXT} = 900\Omega$	80	ı	-	ns
Output rise time of I _{OUT}		t _{OR}	$R_L = 90\Omega$ $C_L = 10pF$		10	25	ns
Output fall	Output fall time of I _{OUT}		2 - 1		10	25	ns

Test Circuit for Switching Characteristics

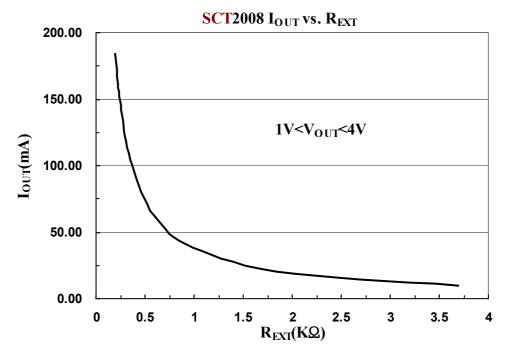


Timing Waveform



Adjusting Output Current

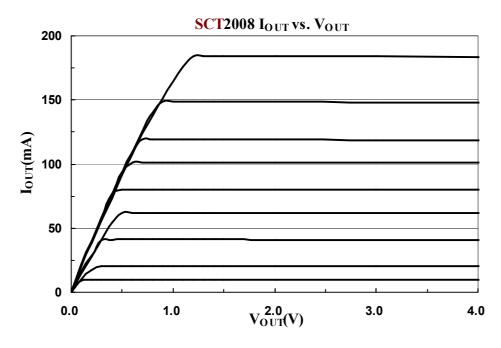
All SCT2008's output current (I_{OUT}) are set by one external resistor at pin REXT. The relationship between I_{OUT} and resistance R_{EXT} is shown as the following figure.



When the SCT2008's output voltage is set between 1 Volt and 4 Volt, the output current can be estimated approximately by: I_{OUT} = 60 (630 / R_{EXT}) (mA) (chip skew < ±6%). Thus the output current are all set to be about 42mA at R_{EXT} = 900 Ω .

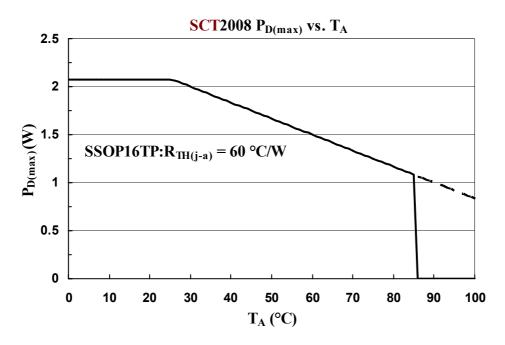
Output Characteristics

The current characteristic of output curve is flat. The output current can kept constant regardless of the variations of LED forward voltage when $V_{OUT} > 1V$. The relationship between I_{OUT} and V_{OUT} is shown below:



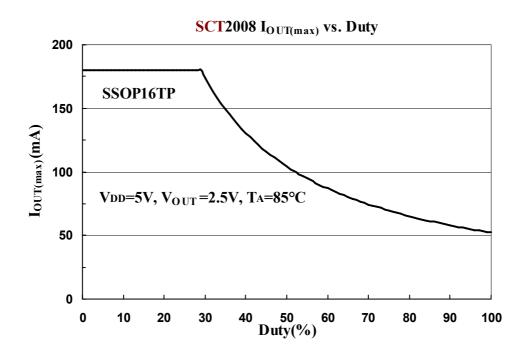
Power Dissipation

The maximum power dissipation ($P_{D(max)}$) of a semiconductor chip varied to different package and ambient temperature. It's determined as $P_{D(max)}=(T_{J(max)}-T_A)/R_{TH(j-a)}$ where $T_{J(max)}$: maximum chip junction temperature usually considered as 150°C, T_A : ambient temperature, $R_{TH(j-a)}$: thermal resistance. Since P=IV, for sink larger I_{OUT} , users are encouraged to add proper voltage reducers on output to reduce the heat generated from the SCT2008.



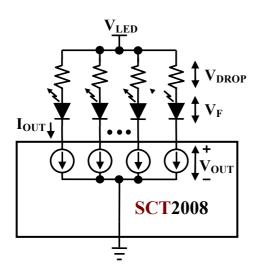
Limitation on Maximum Output Current

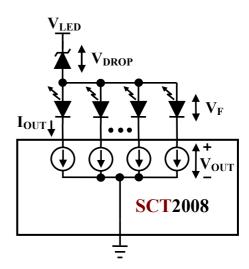
The maximum output current vs. duty cycle is estimated by: $I_{OUT(max)} = (((T_{J(max)} - T_A)/R_{TH(j-a)}) - (V_{DD}*I_{DD}))/V_{OUT}/Duty/N$, where $T_{J(max)} = 150$ °C, N = 8(all ON)



Load Supply Voltage (VLED)

The SCT2008 can be operated very well when V_{OUT} ranging from 1V to 4V. It is recommended to use the lowest possible supply voltage or set a voltage reducer to reduce the V_{OUT} voltage, at the same time reduce the power dissipation of the SCT2008. Follow the diagram instructions shown below to lower down the output voltage. This can be done by adding additional resistor or Zener diode, thus $V_{OUT} = V_{LED} - V_{DROP} - V_F$.



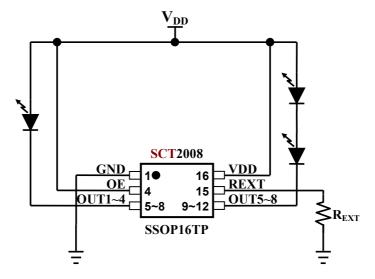


Over Temperature Shutdown

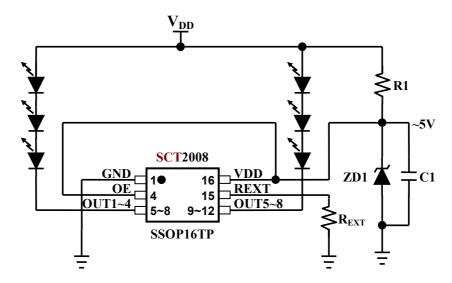
The SCT2008 contains thermal shutdown scheme to prevent damage from over heated. The internal thermal sensor turns off all outputs when the die temperature exceeds $\sim +180^{\circ}$ C. The outputs are enabled again when the die temperature drops below $\sim +130^{\circ}$ C.

Typical Application Circuits

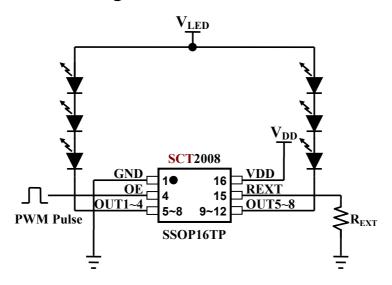
(1) Lighting with recommended V_{DD} =5V



(2) Lighting with $V_{DD} > 5V$, e.g. $V_{DD}=12V/24V$



(3) Lighting with dimming control

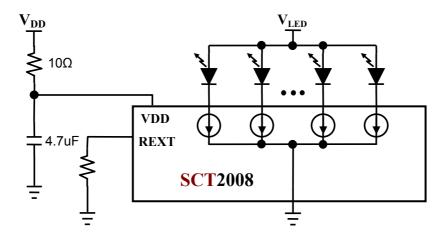


PCB Design Considerations

Use the following general guide-line when designing printed circuit boards (PCB):

Decoupling Capacitor

Place a decoupling capacitor e.g. 4.7uF between VDD and GND pins of the SCT2008. Locate the capacitor as close to the SCT2008 as possible. The necessary capacitance depends on the LED load current and dimming frequency.



External Resistor (R_{EXT})

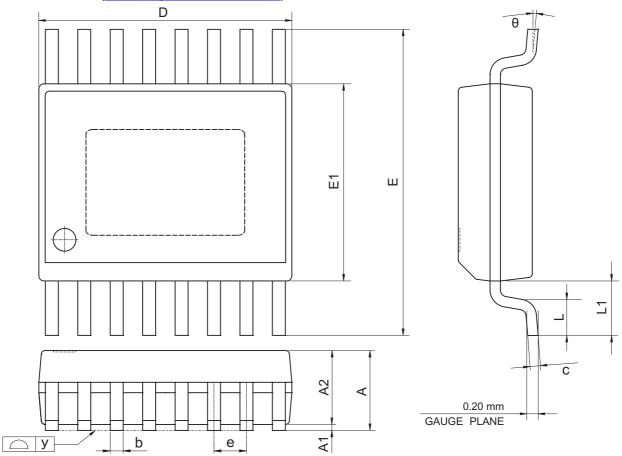
Locate the external resistor as close to the REXT pin in as possible to avoid noise.

Power and Ground

Maximizing the width and minimizing the length of V_{DD} and GND trace improve efficiency and ground bouncing by effect of reducing both power and ground parasitic resistance and inductance. A small value of resistor e.g. 10Ω series in power input of the SCT2008 in conjunction with decoupling capacitor shunting the ICs is recommended. Separating and feeding the LED power from another stable supply terminal V_{LED} is strongly recommended.

Package Dimension

SSOP16TP(check up-to-date version)



Symbol	D	imension (m	m)	Dimension (mil)			
Syllibol	Min.	Nom.	Max.	Min.	Nom.	Max.	
Α	1.35	1.50	1.65	53.1	59.1	65.0	
A1	0.00	-	010	0.0	-	3.9	
A2	-	1.45	-	-	57.1	-	
b	0.20	0.25	0.30	7.9	9.8	11.8	
С	0.19	-	0.25	7.5	-	9.8	
D	4.80	-	5.00	189.0	-	196.9	
Е	5.80	6.00	6.20	228.3	236.2	244.1	
E1	3.80	3.90	4.00	149.6	153.5	157.5	
е	-	0.64	-	-	25.2	-	
L	0.40	-	1.27	15.7	-	50.0	
L1	0.95	1.05	1.15	37.4	41.3	45.3	
у	-	-	0.10	-	_	3.9	
θ	0°	_	8°	0°	_	8°	

Revision History (check up-to-date version)

Data Sheet Version	Remark
V02 01	Description added

Information provided by StarChips Technology is believed to be accurate and reliable. Application circuits shown, if any, are typical examples illustrating the operation of the devices. Starchips can not assume responsibility and any problem raising out of the use of the circuits. Starchips reserves the right to change product specification without prior notice.

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